© Copy	tial Composition right 2005. IPC, Ban ional and Pan-Ameri	nockburn, Illinois.	All rights reserved u	under both	This docume level parts, th	ent is a declaration	ation of the neuron of the ne	ne substances asses all lowe	within the er level mate	manufacture erials for wh	er listed ite hich the m	em. Note anufactu	e: if the item is a irer has engineer	n assembly with lowering responsibility.	
	IPC Web Site for Information on IPC-1752 Standard For   http://www.ipc.org/IPC-175x Dis				pe * Declaration Class * e Class 6 - RoHS Yes/No, Homogeneous Mate					ous Materia	rials and Mfg Information				
Supplier Information															
Company name*	Company u	Company unique ID			Unique ID Authority					Response Date*					
onsemi												2024-04-25			
Contact Name	Title - Cont	Title - Contact			Phone - Contact*					Email - Contact*					
Product-Env-Stewards	Product En	Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com					
Authorized Representative*	Title - Repr	Title - Representative			Phone - Representative*				Email - Representative*						
Product-Env-Stewards	Product En	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com						
Requester Item Nur	Requester Item Number Mfr Item Number FDMA037N08LC					Effective Da	ate Vers	ion	Manufacturing Site		V	Veight*	UOM	Unit Type	
						2024-04-25 TH6			9.44		mg	Each			
Manufacturing Proccess	Information					1	1	I					1	1	
Terminal Plating / G	al Plating / Grid Array Material Termir		Alloy J-STD-020 MSL Ra		L Rating	Peak Process Body Tem		ly Temperatu	ature Max Time at Peak T		Temperature Number of Reflow Cycles		Cycles		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		no CU Alloy	CU Alloy 1			260		C	<b>30</b> se		second	ls 3			
Comments															
evel 1 - maximum time at pea	k temperature duri	ing soldering is 10	30 seconds												
or more information regardi	ng material compos	sition please refer	to page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl othalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.6023	mg	Supplier	Silicon (Si)	7440-21-3		0.6023	mg
Die Attach Tape	0.0776	mg	Supplier	Formaldehyde, polymer with amiline	67784-74-1		0.005	mg
			Supplier	Amines, C36-alkylenedi-, polymers with 5,5'-[(1-methylethylidene)bis(4,1- phenyleneoxy)]bis[1,3- isobenzofurandione], maleated	1224691-98-8		0.005	mg
			Supplier	Bisphenol A, epichlorohydrin polymer	68610-41-3		0.005	mg
			Supplier	Silver (Ag)	7440-22-4		0.0625	mg
Lead Frame	4.0051	mg	Supplier	Zinc (Zn)	7440-66-6		0.0048	mg
			Supplier	Iron (Fe)	7439-89-6		0.0941	mg
			Supplier	Copper (Cu)	7440-50-8		3.905	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0012	mg
Mold Compound-Black	4.612	mg		Epoxy resin	proprietary data		0.2306	mg
			Supplier	Phenolic Resin	Proprietary Data		0.1061	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.2306	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0184	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.1061	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.9202	mg
Plating	0.056	mg	Supplier	Silver (Ag)	7440-22-4		0.0009	mg
			Supplier	Palladium (Pd)	7440-05-3		0.002	mg
			В	Nickel (Ni)	7440-02-0		0.052	mg
			Supplier	Gold (Au)	7440-57-5		0.0011	mg
Wire Bond	0.087	mg	Supplier	Palladium (Pd)	7440-05-3		0.0021	mg
			Supplier	Gold (Au)	7440-57-5		0.0002	mg
			Supplier	Copper (Cu)	7440-50-8		0.0847	mg